

10 TECHNOLOGIES YOU MUST AVOID IN YOUR PRODUCT



TECHNOLOGY #10

High-End Application Processors

✓ Confirm need ☒ ☐

Do you need smartphone-level compute + graphics?

⚠ Risk check ☒ ☐

Locked docs, NDAs, large MOQs, buggy drivers, complex software stacks.

🌿 Safer alternatives: ☒ ☐

STM32/ESP32, Raspberry Pi Compute Module, NXP i.MX series.

→ Action: ☒ ☐

Prototype with accessible MCU/SoC; only move to APs with vendor support + volume.

TECHNOLOGY #9

Custom RF Designs (Sub-GHz)

✓ Confirm need ☒ ☐

Is sub-GHz custom RF truly required?

⚠ Risk check ☒ ☐

Antenna design, tuning, FCC/CE testing, sensitivity to layout/enclosure.

🌿 Safer alternatives: ☒ ☐

Certified modules with pre-tuned antennas (Wi-Fi, Bluetooth, Zigbee, LoRa).

→ Action: ☒ ☐

Start with certified RF modules; validate in real enclosures before scaling.

TECHNOLOGY #8

Custom Battery Packs & Chemistries

✓ Confirm need ☒ ☐

Is custom shape/chemistry unavoidable?

⚠ Risk check ☒ ☐

Safety + transport certification, supplier traceability, long delays.

🌿 Safer alternatives: ☒ ☐

Pre-certified Li-Po/Li-ion packs, coin cells.

→ Action: ☒ ☐

Fit off-the-shelf battery packs; custom only if space demands + budgeted testing.

TECHNOLOGY #7

Advanced USB Features

✓ Confirm need ☒ ☐

Do you need >480 Mbps or >5V/2A power negotiation?

⚠ Risk check ☒ ☐

High-speed routing, impedance control, PD controllers & firmware.

🌿 Safer alternatives: ☒ ☐

USB 2.0 (480 Mbps), simple 5V charging, DC barrel jack.

→ Action: ☒ ☐

Use USB 2.0 for data + standard power unless PD is truly required.

TECHNOLOGY #6

Wireless Charging

✓ Confirm need ☒ ☐

Is wireless charging critical to product appeal?

⚠ Risk check ☒ ☐

Coil alignment, heat, EMI, Qi certification costs.

🌿 Safer alternatives: ☒ ☐

USB-C, pogo pins, magnetic dock.

→ Action: ☒ ☐

Prototype wired first; only add wireless if strong customer demand exists.

TECHNOLOGY #5

Proprietary / High-Speed Connectors

✓ Confirm need ☒ ☐

Is the proprietary/high-speed connector mandatory?

⚠ Risk check ☒ ☐

Licensing (MFi), restricted docs, expensive test setups.

🌿 Safer alternatives: ☒ ☐

USB, HDMI, SPI, I²C, LVDS (widely supported standards).

→ Action: ☒ ☐

Stick to standard connectors; add adapters later if high-speed needed.

TECHNOLOGY #4

Fancy Displays (AMOLED, MIPI-DSI)

✓ Confirm need ☒ ☐

Do you need smartphone-level visuals or just functional UI?

! Risk check ☒ ☐

MIPI DSI forces high-end processors; displays are costly + short supply life.

🌿 Safer alternatives: ☒ ☐

TFT LCDs with SPI or parallel RGB from stable suppliers.

→ Action: ☒ ☐

Prototype with TFT LCD; use AMOLED only in high-volume, high-budget projects.

TECHNOLOGY #3

High-End Analog Audio

✓ Confirm need ☒ ☐

Is audiophile-grade analog performance essential?

! Risk check ☒ ☐

Grounding, shielding, layout, and test equipment requirements.

🌿 Safer alternatives: ☒ ☐

Digital audio (USB, I²S, Bluetooth), or vendor reference analog design.

→ Action: ☒ ☐

Start with codec modules or reference circuits/avoid custom analog unless expert-led.

TECHNOLOGY #2

5G / Cutting-Edge Cellular Modules

✓ Confirm need ☒ ☐

Do you require sustained high throughput or low latency?

! Risk check ☒ ☐

Expensive modules, SIM provisioning, thermal design, carrier approvals

🌿 Safer alternatives: ☒ ☐

LTE Cat-M1, NB-IoT, or 4G pre-certified modules.

→ Action: ☒ ☐

Prototype with LTE/NB-IoT first; only move to 5G if absolutely necessary.

TECHNOLOGY #1

Custom IC Design

✓ Confirm need ☒ ☐

Is extreme integration/volume truly required?

! Risk check ☒ ☐

Huge NRE, mask costs, long lead times, specialized engineers.

🌿 Safer alternatives: ☒ ☐

Huge NRE, mask costs, long lead times, specialized engineers.

→ Action: ☒ ☐

Use off-the-shelf chips; consider custom IC only after scaling + major funding

For Entrepreneurs and Startups:

Develop and launch your electronic product **FASTER** without costly mistakes!

Doing it alone is slow and risky. Small missteps now can become big problems later. Skip the mistakes and launch faster.

→ Frustrated things aren't moving as fast as you want?

Feeling unsure what to do next? ←

Meet your guide: John Teel



Hey there, I'm a former microchip design engineer at Texas Instruments and founder of a hardware startup that sold products in hundreds of retail stores. My chip designs are in devices from Apple, Intel, and more.

Now, my full-time focus is helping people like you bring new electronic products to life, without wasting time, money, or risking everything.

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